Analog Multiplexers/ Demultiplexers with Injection Current Effect Control

Automotive Customized

These devices are pin compatible to standard HC405x and MC1405xB analog mux/demux devices, but feature injection current effect control. This makes them especially suited for usage in automotive applications where voltages in excess of normal logic voltage are common.

The injection current effect control allows signals at disabled analog input channels to exceed the supply voltage range without affecting the signal of the enabled analog channel. This eliminates the need for external diode/resistor networks typically used to keep the analog channel signals within the supply voltage range.

The devices utilize low power silicon gate CMOS technology. The Channel Select and Enable inputs are compatible with standard CMOS outputs.

Features

- Injection Current Cross–Coupling Less than 1 mV/mA (See Figure 10)
- Pin Compatible to HC405X and MC1405XB Devices
- Power Supply Range $(V_{CC} GND) = 2.0 \text{ to } 6.0 \text{ V}$
- In Compliance With the Requirements of JEDEC Standard No. 7 A
- Chip Complexity: 154 FETs or 36 Equivalent Gates
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant



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SOIC-16 D SUFFIX CASE 751B



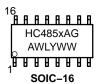


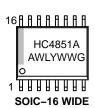


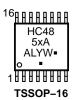
TSSOP-16 DT SUFFIX CASE 948F

QFN16 MN SUFFIX CASE 485AW

MARKING DIAGRAMS









QFN16*
*V4851 marking used for NLV74HC4851AMN1TWG

x = 1 or 2

A = Assembly Location

WL, L = Wafer Lot YY, Y = Year WW, W = Work Week G or ■ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 12 of this data sheet.

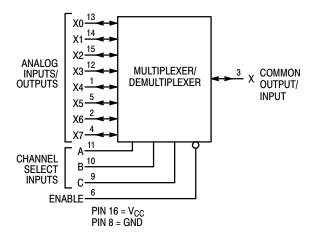


Figure 1. MC74HC4851A Logic Diagram Single-Pole, 8-Position Plus Common Off

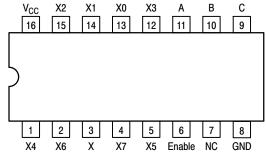


Figure 2. MC74HC4851A 16-Lead Pinout (Top View)

FUNCTION TABLE - MC74HC4851A

| Contr | ol Inp | | | |
|--------|--------|-------|---|-------------|
| | ; | Selec | t | |
| Enable | С | В | Α | ON Channels |
| L | L | L | L | X0 |
| L | L | L | Н | X1 |
| L | L | Н | L | X2 |
| L | L | Н | Н | X3 |
| L | Н | L | L | X4 |
| L | Н | L | Н | X5 |
| L | Н | Н | L | X6 |
| L | Н | Н | Н | X7 |
| Н | X | Χ | Χ | NONE |

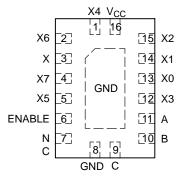


Figure 3. MC74HC4851A QFN Pinout

FUNCTION TABLE - MC74HC4852A

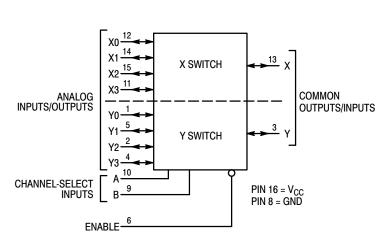
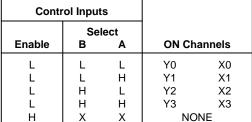


Figure 4. MC74HC4852A Logic Diagram Double-Pole, 4-Position Plus Common Off



X = Don't Care

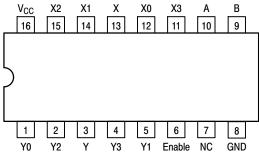


Figure 5. MC74HC4852A 16-Lead Pinout (Top View)

MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|------------------|--|-------------------------------|------|
| V _{CC} | Positive DC Supply Voltage (Referenced to GND) | -0.5 to +7.0 | V |
| V _{in} | DC Input Voltage (Any Pin) (Referenced to GND) | -0.5 to V _{CC} + 0.5 | V |
| - 1 | DC Current, Into or Out of Any Pin | ±25 | mA |
| P _D | Power Dissipation in Still Air, SOIC Package† TSSOP Package† | 500 450 | mW |
| T _{stg} | Storage Temperature Range | -65 to +150 | °C |
| TL | Lead Temperature, 1 mm from Case for 10 Seconds SOIC or TSSOP Package | 260 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

†Derating: SOIC Package: -7 mW/°C from 65° to 125°C TSSOP Package: -6.1 mW/°C from 65° to 125°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND \leq (V_{in} or V_{out}) \leq V_{CC} .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit | |
|---------------------------------|---|--|-------------|--------------------|----|
| V _{CC} | Positive DC Supply Voltage | (Referenced to GND) | 2.0 | 6.0 | V |
| V _{in} | DC Input Voltage (Any Pin) | (Referenced to GND) | GND | V _{CC} | V |
| V _{IO} * | Static or Dynamic Voltage Across Switch | | 0.0 | 1.2 | V |
| T _A | Operating Temperature Range, All Package Types | | - 55 | +125 | °C |
| t _r , t _f | Input Rise/Fall Time (Channel Select or Enable Inputs) | $V_{CC} = 2.0 \text{ V}$ $V_{CC} = 4.5 \text{ V}$ $V_{CC} = 6.0 \text{ V}$ | 0 0 0 | 1000 500 400 | ns |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC CHARACTERISTICS — Digital Section (Voltages Referenced to GND) V_{EE} = GND, Except Where Noted

| | | | v _{cc} | Guaranteed Limit | | nit | | |
|-----------------|--|--|--------------------------|------------------------------|------------------------------|------------------------------|------|--|
| Symbol | Parameter | Condition | V | –55 to 25°C | ≤85°C | ≤125°C | Unit | |
| V _{IH} | Minimum High–Level Input Voltage, Channel–Select or Enable Inputs | R _{on} = Per Spec | 2.0 3.0 4.5 6.0 | 1.50 2.10 3.15 4.20 | 1.50 2.10 3.15 4.20 | 1.50 2.10 3.15 4.20 | V | |
| V _{IL} | Maximum Low–Level Input Voltage, Channel–Select or Enable Inputs | R _{on} = Per Spec | 2.0 3.0 4.5 6.0 | 0.50 0.90 1.35 1.80 | 0.50 0.90 1.35 1.80 | 0.50 0.90 1.35 1.80 | V | |
| I _{in} | Maximum Input Leakage Current on Digital Pins (Enable/A/B/C) | V _{in} = V _{CC} or GND | 6.0 | ±0.1 | ±1.0 | ±1.0 | μΑ | |
| Icc | Maximum Quiescent Supply Current (per Package) | $V_{in(digital)} = V_{CC}$ or GND $V_{in(analog)} = GND$ | 6.0 | 2 | 20 | 40 | μА | |

^{*}For voltage drops across switch greater than 1.2 V (switch on), excessive V_{CC} current may be drawn; i.e., the current out of the switch may contain both V_{CC} and switch input components. The reliability of the device will be unaffected unless the Maximum Ratings are exceeded.

DC CHARACTERISTICS — Analog Section

| | | | | Guara | nteed Lim | nit | |
|------------------|---|--|--------------------------|----------------------------|----------------------------|----------------------------|------|
| Symbol | Parameter | Condition | v _{cc} | -55 to 25°C | ≤85°C | ≤125°C | Unit |
| R _{on} | Maximum "ON" Resistance | $V_{\text{in}} = V_{\text{IL}} \text{ or } V_{\text{IH}}; V_{\text{IS}} = V_{\text{CC}} \text{ to}$ GND (Note 1); $I_{\text{S}} \le 2.0 \text{ mA}$ (Note 2) | 2.0 3.0 4.5 6.0 | 1700 1100 550 400 | 1750 1200 650 500 | 1800 1300 750 600 | Ω |
| ΔR_{on} | Delta "ON" Resistance | $V_{\text{in}} = V_{\text{IL}} \text{ or } V_{\text{IH}}; V_{\text{IS}} = V_{\text{CC}}/2$ (Note 1); $I_{\text{S}} \le 2.0 \text{ mA}$ (Note 2) | 2.0 3.0 4.5 6.0 | 300 160 80 60 | 400 200 100 80 | 500 240 120 100 | Ω |
| l _{off} | Maximum Off-Channel Leakage Current, Any One Channel Common Channel | V _{in} = V _{CC} or GND | 6.0 | ±0.1 ±0.1 | ±0.1 ±0.1 | ±0.1 ±0.1 | μΑ |
| I _{on} | Maximum On-Channel Leakage Channel-to-Channel | V _{in} = V _{CC} or GND | 6.0 | ±0.1 | ±0.1 | ±0.1 | μΑ |

AC CHARACTERISTICS ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

| Symbol | Parameter | V _{CC} | -55 to 25°C | ≤85°C | ≤125°C | Unit |
|---|--|--------------------------|------------------------|------------------------|-------------------------|------|
| t _{PHL} , t _{PLH} | Maximum Propagation Delay, Analog Input to Analog Output | 2.0 3.0 4.5 6.0 | 160 80 40 30 | 180 90 45 35 | 200 100 50 40 | ns |
| t _{PHL} , t _{PHZ,PZH} t _{PLH} , t _{PLZ,PZL} | Maximum Propagation Delay, Enable or Channel-Select to Analog Output | 2.0 3.0 4.5 6.0 | 260 160 80 78 | 280 180 90 80 | 300 200 100 80 | ns |
| C _{in} | Maximum Input Capacitance Digital Pins (All Switches Off) Any Single Analog Pin (All Switches Off) Common Analog Pin | | 10 35 40 | 10 35 40 | 10 35 40 | pF |
| C _{PD} | Power Dissipation Capacitance Typical | 5.0 | 20 | | | pF |

INJECTION CURRENT COUPLING SPECIFICATIONS (V $_{CC}$ = 5V, T_A = -55°C to +125°C)

| Symbol | Parameter | Condition | Тур | Max | Unit |
|-------------------|-----------|--|--------------------------|-------------------------|------|
| VΔ _{out} | | $\begin{split} & I_{in}{}^{*} \leq 1 \text{ mA, } R_{S} \leq 3,9 \text{ k}\Omega \\ & I_{in}{}^{*} \leq 10 \text{ mA, } R_{S} \leq 3,9 \text{ k}\Omega \\ & I_{in}{}^{*} \leq 1 \text{ mA, } R_{S} \leq 20 \text{ k}\Omega \\ & I_{in}{}^{*} \leq 10 \text{ mA, } R_{S} \leq 20 \text{ k}\Omega \end{split}$ | 0.1 1.0 0.5 5.0 | 1.0 5.0 2.0 20 | mV |

^{*} I_{in} = Total current injected into all disabled channels.

V_{IS} is the input voltage of an analog I/O pin.
 I_S is the currebnt flowing in or out of analog I/O pin.

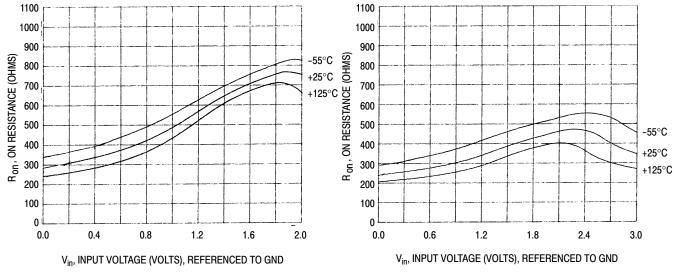


Figure 6. Typical On Resistance V_{CC} = 2V

Figure 7. Typical On Resistance $V_{CC} = 3V$

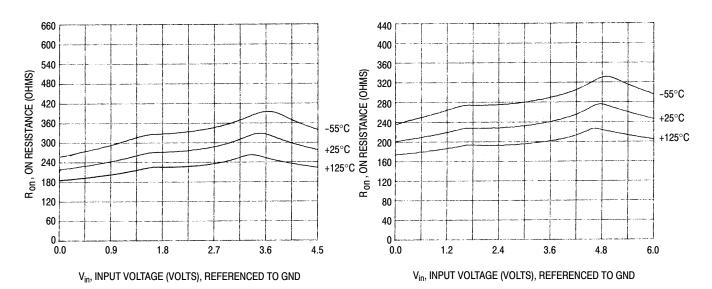


Figure 8. Typical On Resistance $V_{CC} = 4.5V$

Figure 9. Typical On Resistance $V_{CC} = 6V$

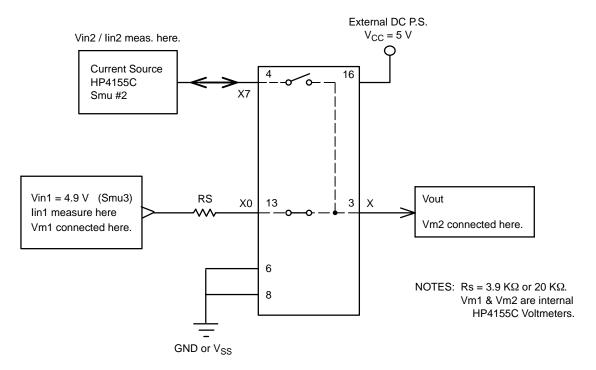


Figure 10. Injection Current Coupling Specification

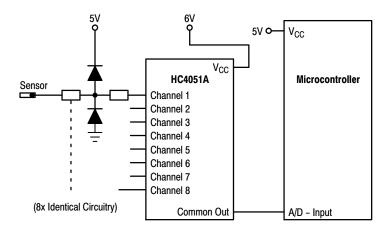


Figure 11. Actual Technology

Requires 32 passive components and one extra 6V regulator to suppress injection current into a standard HC4051 multiplexer

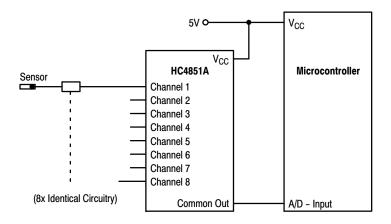


Figure 12. MC74HC4851A Solution Solution by applying the HC4851A multiplexer

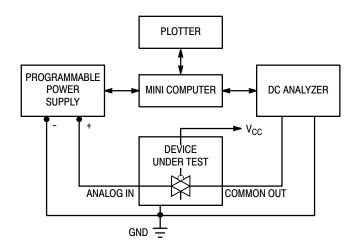


Figure 13. On Resistance Test Set-Up

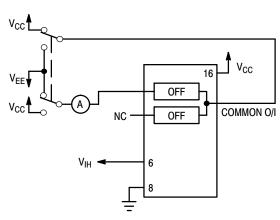


Figure 14. Maximum Off Channel Leakage Current, Any One Channel, Test Set-Up

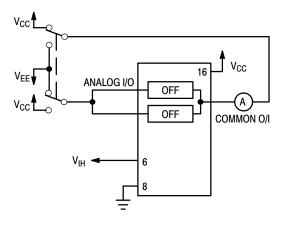


Figure 15. Maximum Off Channel Leakage Current, Common Channel, Test Set-Up

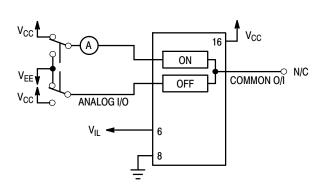


Figure 16. Maximum On Channel Leakage Current, Channel to Channel, Test Set-Up

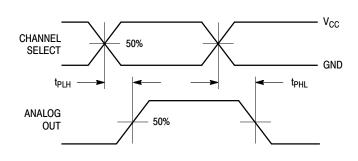
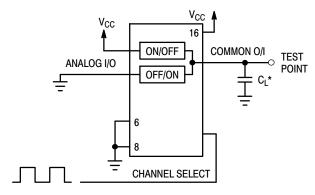
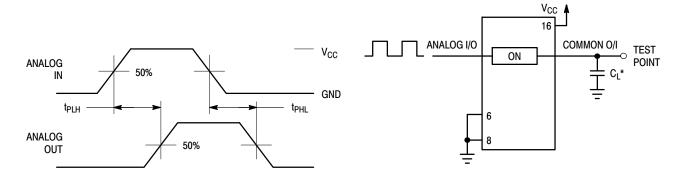


Figure 17. Propagation Delays, Channel Select to Analog Out



*Includes all probe and jig capacitance

Figure 18. Propagation Delay, Test Set-Up Channel Select to Analog Out



*Includes all probe and jig capacitance

Figure 19. Propagation Delays, Analog In to Analog Out

Figure 20. Propagation Delay, Test Set-Up
Analog In to Analog Out

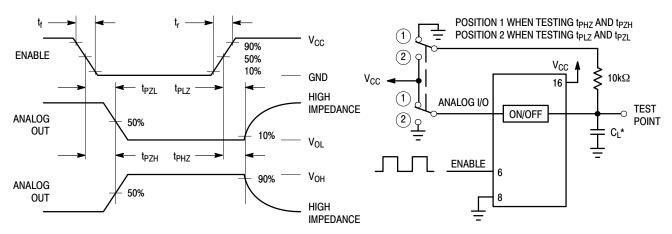


Figure 21. Propagation Delays, Enable to Analog Out

Figure 22. Propagation Delay, Test Set-Up Enable to Analog Out

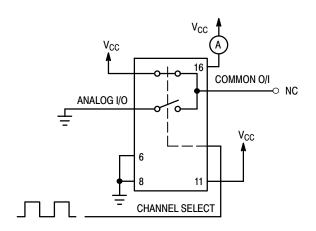


Figure 23. Power Dissipation Capacitance, Test Set-Up

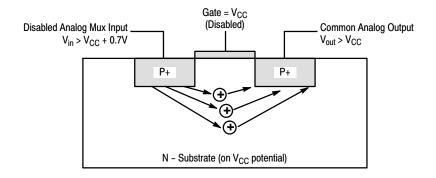


Figure 24. Diagram of Bipolar Coupling Mechanism

Appears if V_{in} exceeds V_{CC} , driving injection current into the substrate

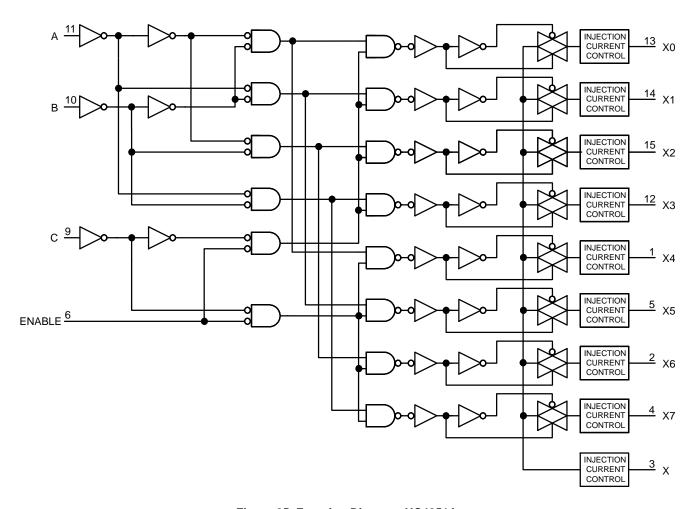


Figure 25. Function Diagram, HC4851A

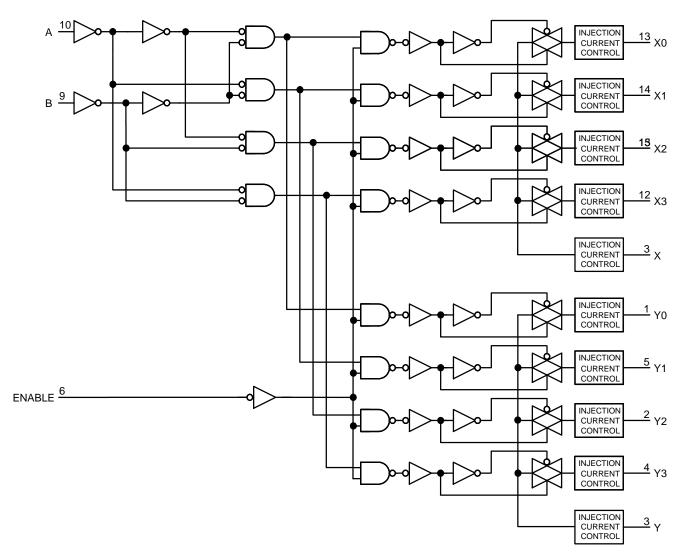


Figure 26. Function Diagram, HC4852A

ORDERING INFORMATION

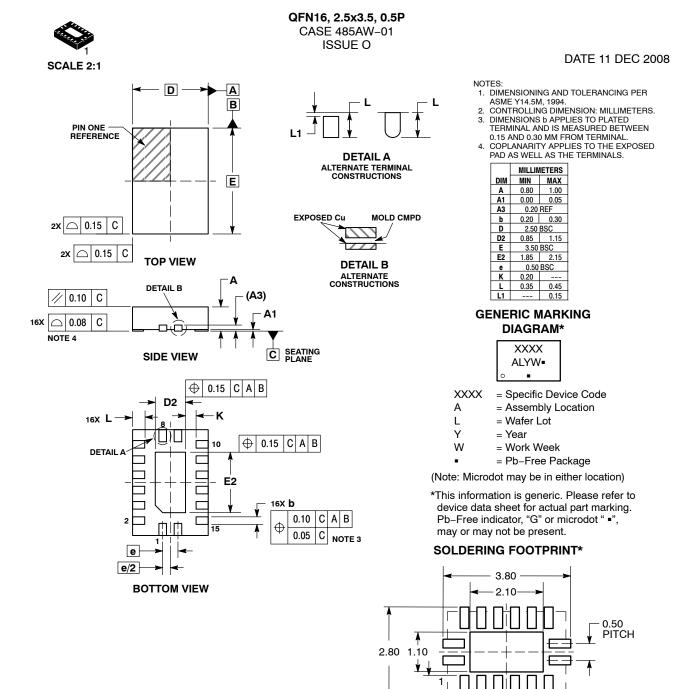
| Device | Package | Shipping [†] |
|----------------------|----------------------|--------------------------|
| MC74HC4851ADG | | 48 Units / Rail |
| MC74HC4851ADR2G | SOIC-16 (Pb-Free) | 2500 Units / Tape & Reel |
| NLVHC4851ADR2G* | ((3.133) | 2500 Units / Tape & Reel |
| MC74HC4851ADTR2G | TSSOP-16 | 2500 Units / Tape & Reel |
| NLVHC4851ADTR2G* | (Pb-Free) | |
| MC74HC4851ADWR2G | SOIC-16 WIDE | 1000 Units / Tape & Reel |
| NLVHC4851ADWR2G* | (Pb-Free) | |
| NLV74HC4851AMNTWG*# | QFN16 | 3000 Units / Tape & Reel |
| NLV74HC4851AMN1TWG*# | (Pb-Free) | 3000 Units / Tape & Reel |

| MC74HC4852ADG | | 48 Units / Rail |
|-------------------|----------------------|--------------------------|
| MC74HC4852ADR2G | SOIC-16 (Pb-Free) | 2500 Units / Tape & Reel |
| NLV74HC4852ADR2G* | , | 2500 Units / Tape & Reel |
| MC74HC4852ADTR2G | TSSOP-16 | 2500 Units / Tape & Reel |
| NLVHC4852ADTR2G* | (Pb-Free) | |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

[#]MN suffix is with pull-back lead, MN1 is without pull-back lead. Refer to 'Detail A' of case outline on page 16.



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

16X

0.30

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| DESCRIPTION: | QFN16, 2.5X3.5, 0.5P | | PAGE 1 OF 1 | | | |

16X 0.60

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PACKAGE

MECHANICAL CASE OUTLINE



DATE 29 DEC 2006

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI
- THE NOTION AND TOLETANOING FER ANSI'Y 14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
- PHOI HUSION.

 MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.

 DIMENSION D DOES NOT INCLUDE DAMBAR
 PROTRUSION. ALLOWABLE DAMBAR PROTRUSION

 SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D

 DIMENSION AT MAXIMUM MATERIAL CONDITION.

| | MILLIN | IETERS | INC | HES |
|-----|--------|----------|-------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 9.80 | 10.00 | 0.386 | 0.393 |
| В | 3.80 | 4.00 | 0.150 | 0.157 |
| C | 1.35 | 1.75 | 0.054 | 0.068 |
| D | 0.35 | 0.49 | 0.014 | 0.019 |
| F | 0.40 | 1.25 | 0.016 | 0.049 |
| G | 1.27 | 1.27 BSC | | BSC |
| 7 | 0.19 | 0.25 | 0.008 | 0.009 |
| K | 0.10 | 0.25 | 0.004 | 0.009 |
| M | 0° | 7° | 0° | 7° |
| Р | 5.80 | 6.20 | 0.229 | 0.244 |
| R | 0.25 | 0.50 | 0.010 | 0.019 |

| STYLE 1: | | STYLE 2: | | STYLE 3: | | STYLE 4: | | | |
|----------|---------------|----------|---------------|----------|----------------------|----------|----------------|-------------|-------------------------|
| PIN 1. | | PIN 1. | | PIN 1. | COLLECTOR, DYE #1 | PIN 1. | COLLECTOR, DYE | #1 | |
| 2. | | | ANODE | 2. | BASE, #1 | 2. | COLLECTOR, #1 | | |
| 3. | EMITTER | 3. | NO CONNECTION | 3. | EMITTER, #1 | 3. | COLLECTOR, #2 | | |
| 4. | NO CONNECTION | 4. | CATHODE | 4. | COLLECTOR, #1 | 4. | COLLECTOR, #2 | | |
| 5. | EMITTER | 5. | CATHODE | 5. | COLLECTOR, #2 | 5. | COLLECTOR, #3 | | |
| 6. | BASE | 6. | NO CONNECTION | 6. | BASE, #2 | 6. | COLLECTOR, #3 | | |
| 7. | COLLECTOR | 7. | ANODE | 7. | EMITTER, #2 | 7. | COLLECTOR, #4 | | |
| 8. | COLLECTOR | | | 8. | COLLECTOR, #2 | 8. | COLLECTOR, #4 | | |
| 9. | BASE | | CATHODE | 9. | COLLECTOR, #3 | 9. | BASE, #4 | | |
| 10. | EMITTER | 10. | ANODE | 10. | BASE, #3 | 10. | EMITTER, #4 | | |
| 11. | NO CONNECTION | 11. | | 11. | EMITTER, #3 | 11. | BASE, #3 | | |
| 12. | EMITTER | | CATHODE | 12. | | 12. | | | |
| 13. | BASE | | CATHODE | 13. | COLLECTOR, #4 | 13. | BASE, #2 | SOI DEDING | FOOTPRINT |
| 14. | | | NO CONNECTION | 14. | BASE, #4 | 14. | EMITTER, #2 | SOLDERING | FOOTFRINT |
| 15. | EMITTER | | ANODE | 15. | EMITTER, #4 | 15. | BASE, #1 | 8 | ЗX |
| 16. | COLLECTOR | 16. | CATHODE | 16. | COLLECTOR, #4 | 16. | EMITTER, #1 | - 6 | .40 ──── |
| | | | | | | | | - | - |
| STYLE 5: | | STYLE 6: | | STYLE 7: | | | | | 16X 1.12 < |
| PIN 1. | DRAIN, DYE #1 | | CATHODE | PIN 1. | SOURCE N-CH | | | | , |
| 2. | DRAIN. #1 | | CATHODE | 2. | COMMON DRAIN (OUTPUT |) | | . 🗀 1 | 16 |
| 3. | DRAIN, #2 | | CATHODE | 3. | COMMON DRAIN (OUTPUT | | | , | '' |
| 4. | DRAIN, #2 | 4. | CATHODE | 4. | GATE P-CH | , | | | |
| 5. | DRAIN, #3 | 5. | CATHODE | 5. | COMMON DRAIN (OUTPUT |) | 16 | 5X T | |
| 6. | DRAIN, #3 | 6. | CATHODE | 6. | COMMON DRAIN (OUTPUT | | 0.5 | | ' <u> </u> |
| 7. | DRAIN, #4 | 7. | CATHODE | 7. | COMMON DRAIN (OUTPUT | | 0.0 | | |
| 8. | DRAIN, #4 | 8. | CATHODE | 8. | SOURCE P-CH | , | | | |
| 9. | GATE, #4 | 9. | ANODE | 9. | SOURCE P-CH | | | | |
| 10. | SOURCE, #4 | 10. | ANODE | 10. | COMMON DRAIN (OUTPUT |) | | | |
| 11. | GATE, #3 | 11. | ANODE | 11. | COMMON DRAIN (OUTPUT | | | | |
| 12. | SOURCE, #3 | 12. | ANODE | 12. | COMMON DRAIN (OUTPUT | | | | |
| 13. | GATE, #2 | 13. | ANODE | 13. | GATE N-CH | , | | | ¦ |
| 14. | SOURCE, #2 | 14. | ANODE | 14. | COMMON DRAIN (OUTPUT |) | | | ▼ PITCH |
| 15. | GATE, #1 | 15. | ANODE | 15. | COMMON DRAIN (OUTPUT | | | | <u>+-+</u> |
| 16. | SOURCE, #1 | 16. | ANODE | 16. | SOURCE N-CH | , | | | |
| | - / | | | | | | | □ 8 | 9 + - + - |
| | | | | | | | | • | , |
| | | | | | | | | | BINENIOLONIO MILLINETTE |
| | | | | | | | | | DIMENSIONS: MILLIMETERS |

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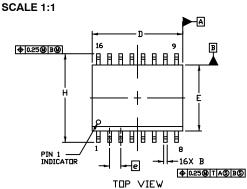


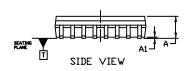


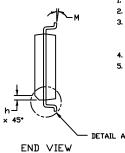
SOIC-16 WB CASE 751G ISSUE E

DATE 08 OCT 2021









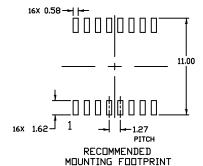


DETAIL A

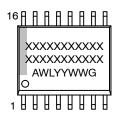
NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS
- DIMENSION 6 DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
- MAXIMUM MOLD PROTRUSION OR FLASH TO BE 0.15 PER SIDE.

| | MILLIMETERS | | |
|-----|-------------|-------|--|
| DIM | MIN. | MAX. | |
| Α | 2.35 | 2.65 | |
| A1 | 0.10 | 0.25 | |
| В | 0.35 | 0.49 | |
| С | 0.23 | 0.32 | |
| D | 10.15 | 10.45 | |
| E | 7.40 | 7.60 | |
| е | 1.27 BSC | | |
| Н | 10.05 | 10.55 | |
| h | 0.53 REF | | |
| ١ | 0.50 | 0.90 | |
| М | 0* | 7* | |



GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code = Assembly Location

WL = Wafer Lot YY = Year ww = Work Week = Pb-Free Package

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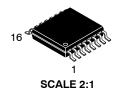
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^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

0.10 (0.004)

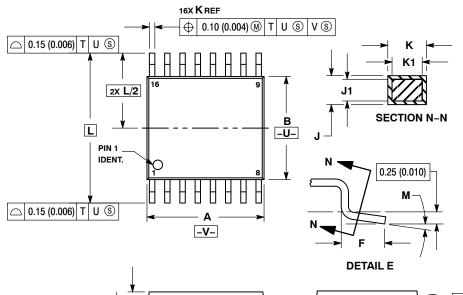
D

-T- SEATING PLANE



TSSOP-16 CASE 948F-01 ISSUE B

DATE 19 OCT 2006



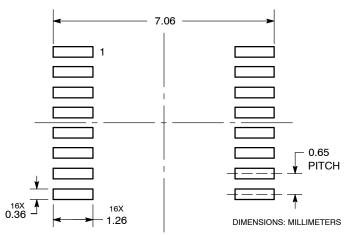
NOTES

- JIES:
 DIMENSIONING AND TOLERANCING PER
 ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A DOES NOT INCLUDE MOLD
 FLASH. PROTRUSIONS OR GATE BURRS.
 MOLD EL ROLL OF GATE BURDS SUAL NO.
- MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.
 INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
- DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION. TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY.
- DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 4.90 | 5.10 | 0.193 | 0.200 |
| В | 4.30 | 4.50 | 0.169 | 0.177 |
| С | | 1.20 | | 0.047 |
| D | 0.05 | 0.15 | 0.002 | 0.006 |
| F | 0.50 | 0.75 | 0.020 | 0.030 |
| G | 0.65 BSC | | 0.026 BSC | |
| Н | 0.18 | 0.28 | 0.007 | 0.011 |
| J | 0.09 | 0.20 | 0.004 | 0.008 |
| J1 | 0.09 | 0.16 | 0.004 | 0.006 |
| K | 0.19 | 0.30 | 0.007 | 0.012 |
| K1 | 0.19 | 0.25 | 0.007 | 0.010 |
| L | 6.40 BSC | | 0.252 BSC | |
| M | 0° | 8° | 0° | 8 ° |



G



GENERIC MARKING DIAGRAM*

168888888 XXXX XXXX **ALYW** 188888888

XXXX = Specific Device Code Α = Assembly Location

= Wafer Lot L Υ = Year W = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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DETAIL E

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